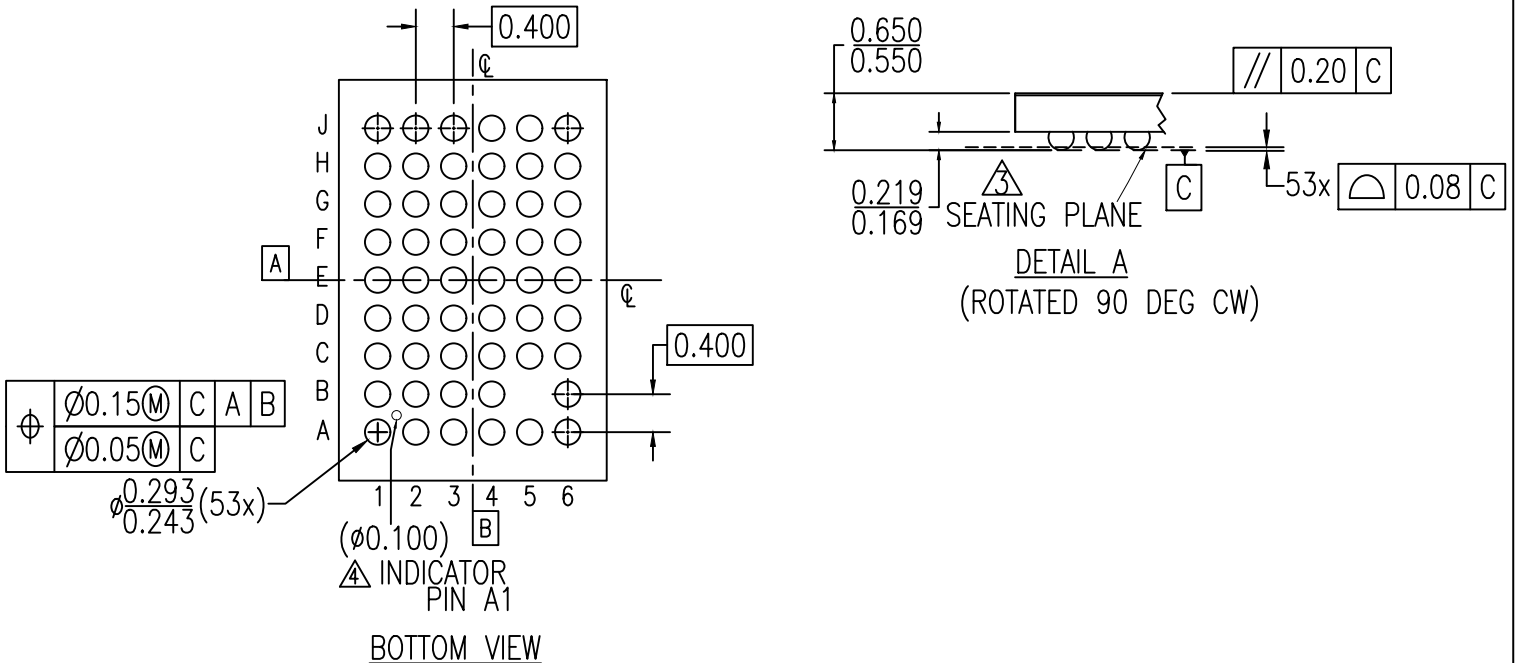
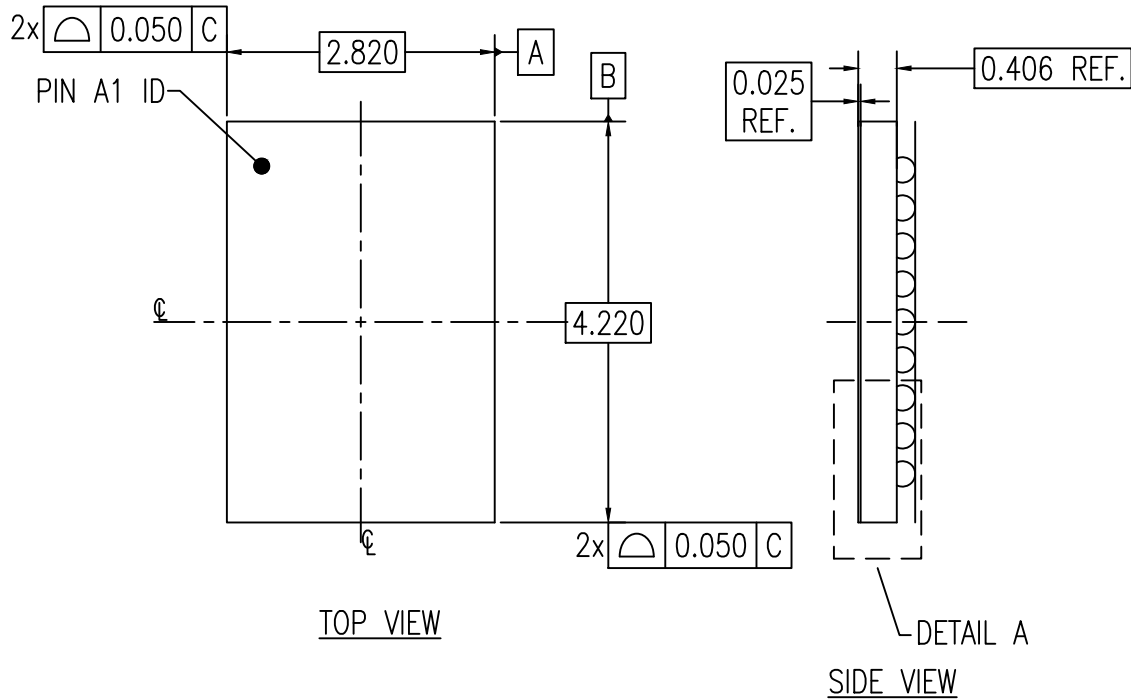
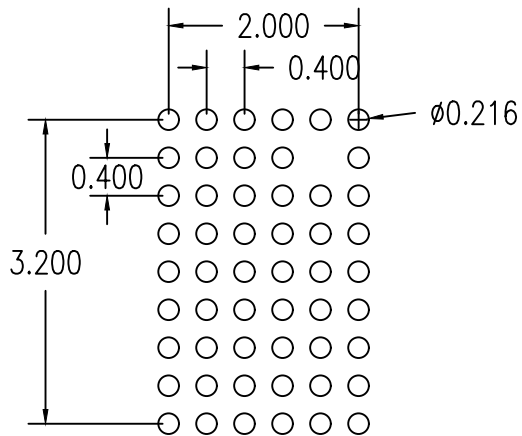


**NOTES:**

1. ALL DIMENSIONS AND TOLERANCES ARE PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. SEATING PLANE AND PRIMARY DATUM -C- ARE DEFINED BY THE CONTACT POINTS OF THREE OR MORE SOLDER BALLS THAT SUPPORT THE DEVICE WHEN PLACED ON A TOP OF A PLANAR SURFACE.
4. BOTTOM PIN#1 INDICATOR OPTIONAL.
5. BALL SIZE BEFORE REFLOW IS 0.25mm.





### RECOMMENDED LAND PATTERN DIMENSION

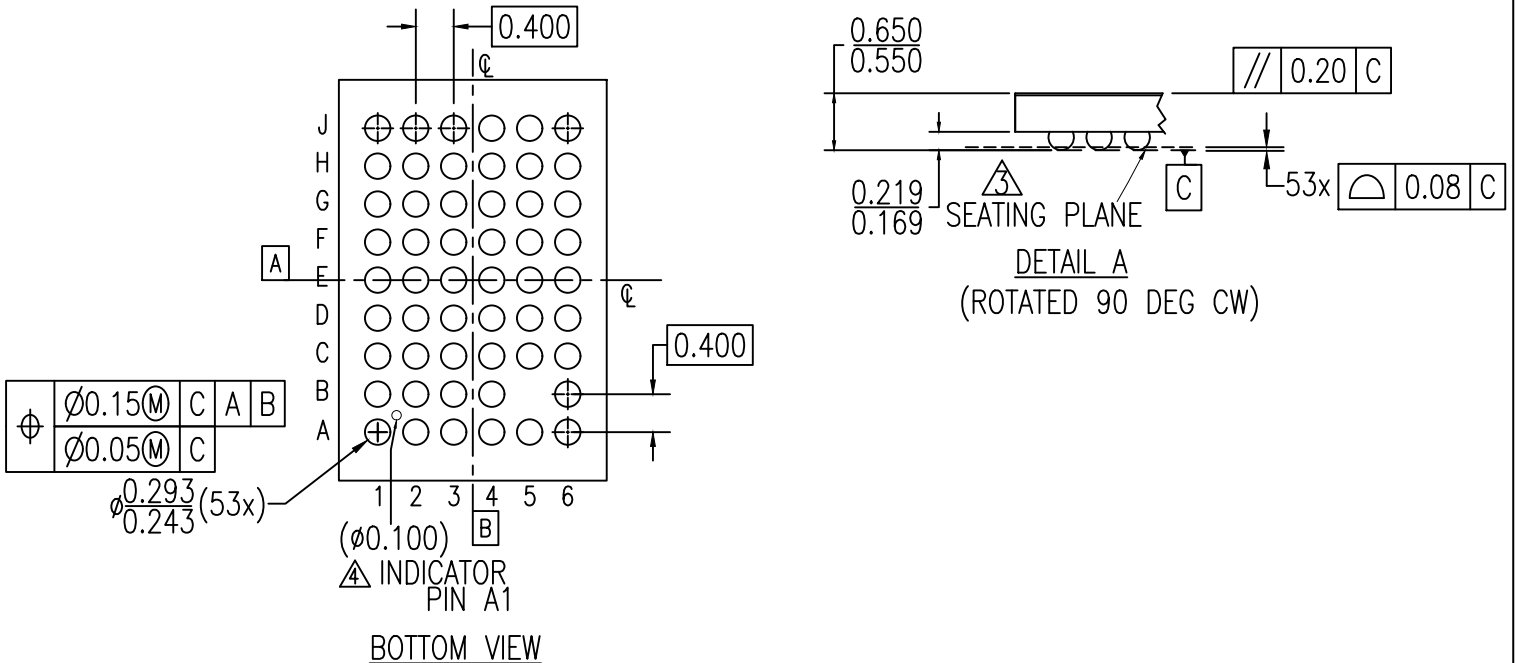
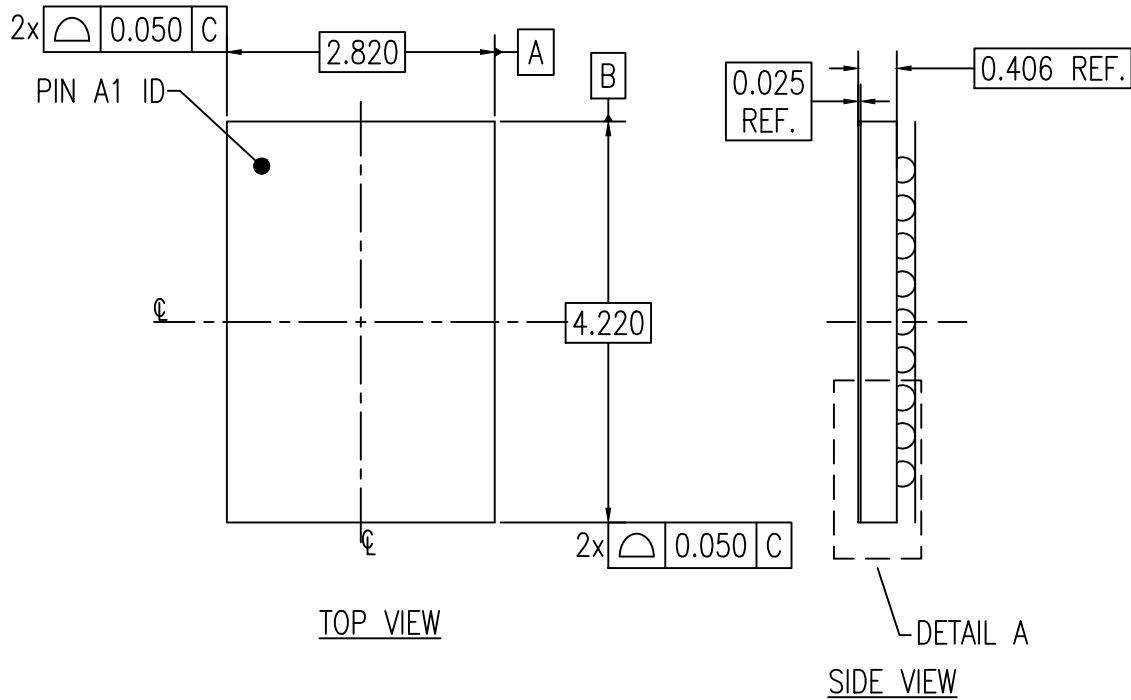
**NOTE:**

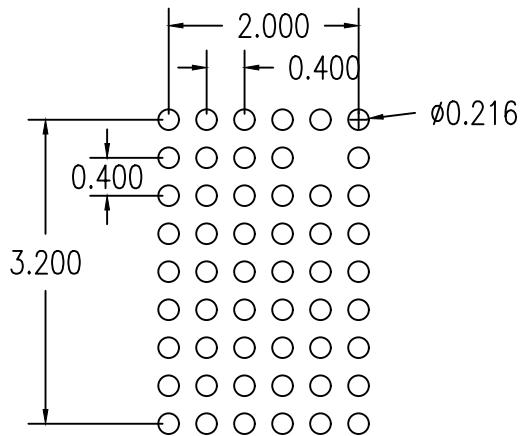
1. ALL DIMENSIONS ARE IN MM, ANGLES IN DEGREES.
2. TOP DOWN VIEW, AS VIEW ON PCB.
3. NSMD LAND PATTERN ASSUMED.
4. LAND PATTERN RECOMMENDATION AS PER IPC-7351  
GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

| Package Revision History |         |   |
|--------------------------|---------|---|
| Date Created             | Rev No. | Description                             |
| April 29, 2019           | Rev 01. | Change Ball Size Land Pattern Dimension |
| Feb 4, 2019              | Rev 00  | Initial Release                         |

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